

Grazing incidence EUV surface metrology: Benchmarking of DPP source table-top scatterometry versus PTB synchrotron based EUV-Radiometry

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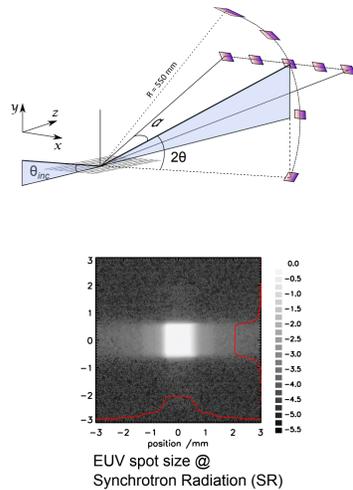


Motivation

Optical scatterometry is a powerful technique for surface roughness metrology and profile characterization of nano-structured layered surfaces. Besides being a fast, non-contact and non-destructive method, it provides spectrally resolved data on the roughness power spectral density (PSD). Roughness became a very sensitive parameter to be considered, as the wavelength decreases. Accessing scatterometry measurements with laboratory sources could be an advantage for industrial characterization of sub-nanometer rough surfaces.

Scatterometry at PTB Radiometry beamline (MLS)

The EUV-Radiometry beamline at the Metrology Light Source (MLS) [1] provides a stable and well defined beam for the EUV-reflectometer. The scattered light is recorded by scanning the angular range with a diode of 4.5 mm x 4.5 mm size at a sample-detector distance of 550 mm. The effective angular resolution is 0.48° and the corresponding solid angle is 1.67 μsr. The diode signal was measured with a Keithley Model-617 programmable electrometer. The darkcurrent was as low as 0.2E-12 A. The standard spot size for this measurement was 1 mm x 1 mm.



Scatterometry with table-top setup and DPP source

The table-top scatterometer setup [2] is powered by a Fraunhofer-ILT discharge-produced plasma (DPP) source FS-5420 [3]. It creates a pinch with diameter 0.5 mm and length 2 mm by exciting Xe gas, pulsing at 1 - 1.5 kHz. Typical pulse duration is around 10 ns and pulse energy 3 - 6 mJ/sr at 13.5 nm 2%BW. After spectral and spatial filtering ca. 10¹⁵ photons are delivered to the sample plane in a 170 μm spot (FWHM) during 10 min of exposure time.

The scattered light in the table-top scatterometer was detected with an Andor DX434-BN camera. It uses 16-bit digitalization and a back-illuminated thinned CCD sensor of e2v CCD47-10 with 1024x1024 square pixels of 13 μm x 13 μm size. The full-well-capacity of each pixel is limited to 90160 e-. Setting A/D Rate to 62 kHz (16 μs readout) increases sensitivity to 1.4 e-/count and expands dynamic range to 16-bit.

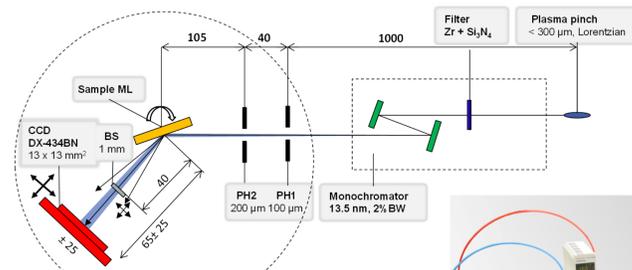
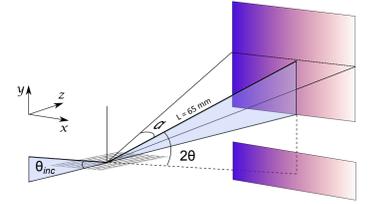
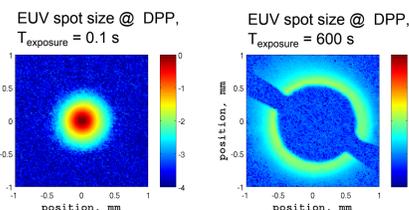
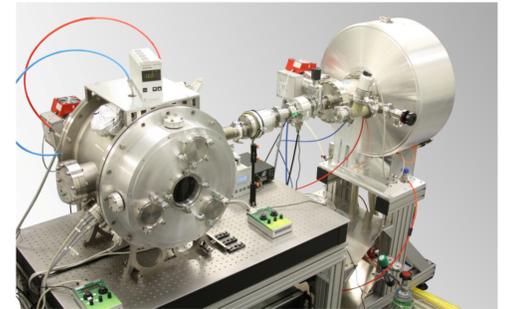


Photo of table-top scatterometer with DPP source



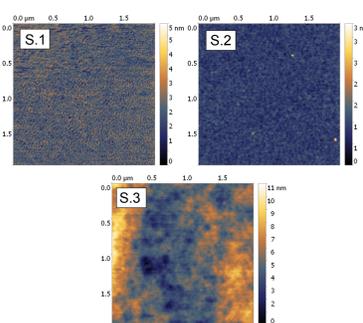
Test samples

Three samples (S.1 - S.3) in total were under investigation. Samples are Si-wafers coated with different periodic multilayer (ML) structure by magnetron sputtering.

RMS roughness (R_q) was measured with AFM at least in 5 different areas of 2 μm x 2 μm size and averaged.

Table 1. List of samples used for scattering measurements

Sample Nr.	Surface type	Layers	R _q , nm
01	ML: B ₄ C/CeO ₂	40	0.45
02	ML: B ₄ C/CeO ₂	10	0.38
03	ML: Mo/Si	60	1.34



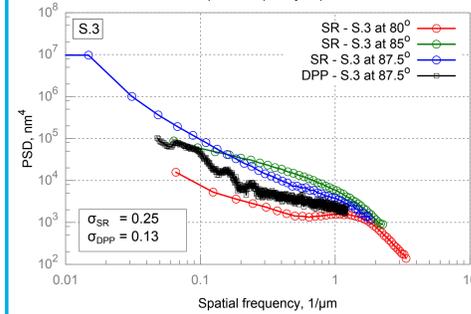
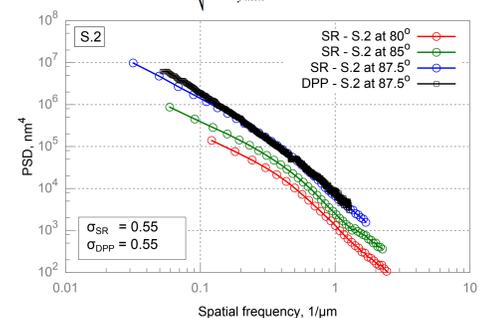
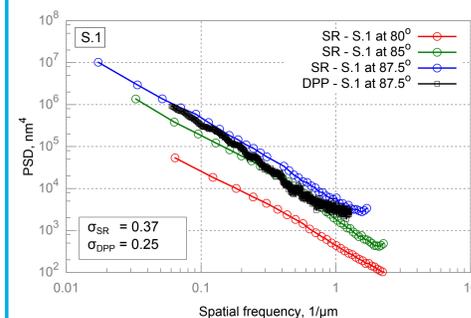
Power Spectral Density (PSD) analysis

For every sample surface Angular Resolved Scattering (ARS) was measured at three AOIs: [80°, 85°, 87.5°] and compared at 87.5° with data from the table-top scatterometer.

According to Rayleigh-Rice (RR) surface scatter ARS can be represented in terms of a two-dimensional surface PSD function. By integration PSD over frequency band, σ_{rms} can be derived.

$$ARS(\theta_s) = \frac{16\pi^2}{\lambda^4} \cos \theta_i (\cos \theta_s)^2 Q_r PSD(f)$$

$$\sigma_{rms} = \sqrt{2\pi \int_{f_{min}}^{f_{max}} PSD(f) f df}$$

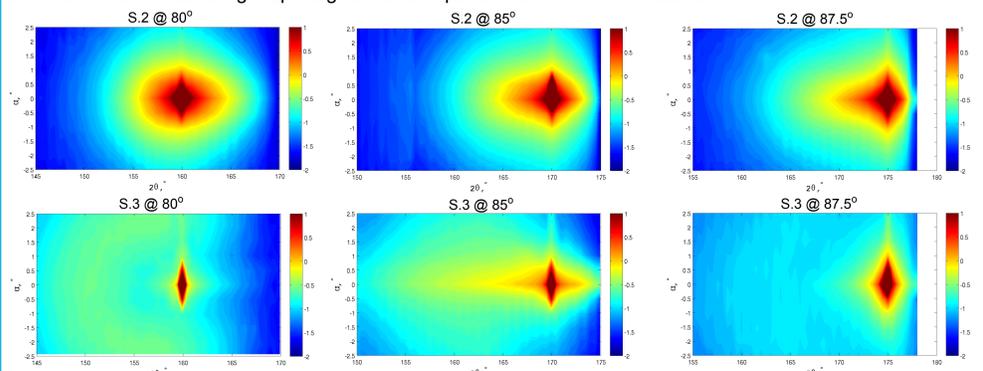


Measured PSD for three different sample surfaces compared between two setups: one with synchrotron radiation (SR) and one with DPP source.

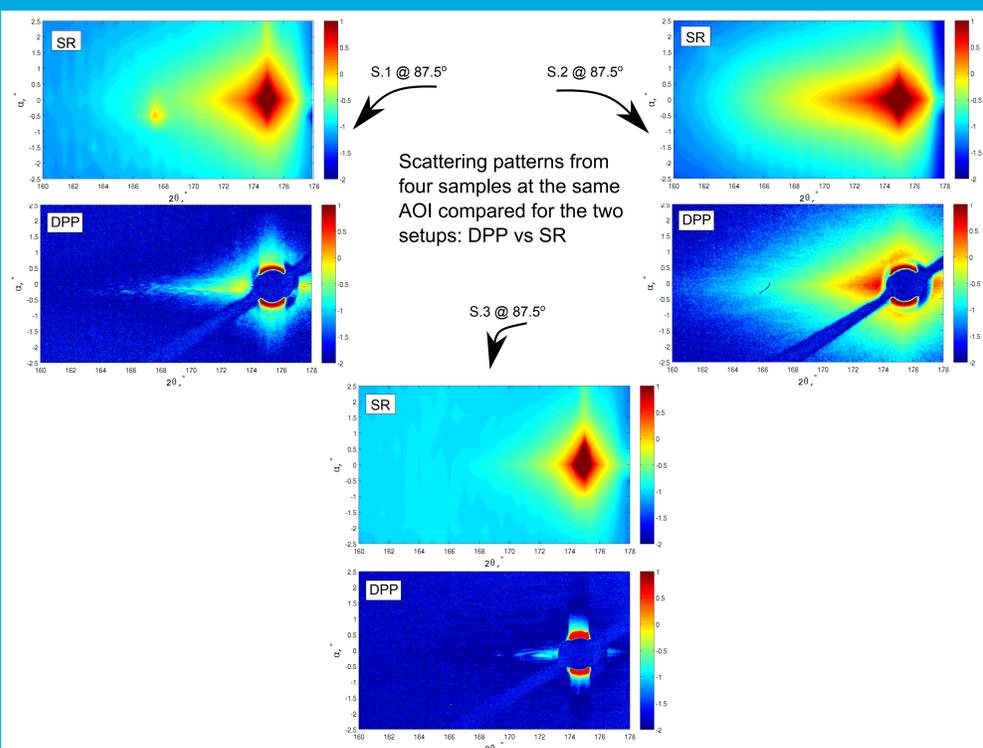
Angle dependent polarization reflectance coefficient Q_r was not taken into consideration for PSD derivation. Further evaluation is underway to determine it for different AOI.

Scattering patterns: AOI-scan @ SR

2D scattering maps at three different AOI = [80°, 85°, 87.5°] were recorded at λ = 13.51 nm for every sample surface. A set of scattering maps is given for comparison of two ML surfaces: S.2 and S.3.



Scattering patterns: DPP vs SR



Conclusions

We compared measurements of angular resolved diffuse EUV scatter under grazing incidence using a DPP source based laboratory set-up with measurements using synchrotron radiation at the PTB laboratory at the storage ring MLS.

- The laboratory set-up was dedicated to scatterometry and used a CCD-detector with integration times of up to 10 min. The PTB reference measurements were done with the EUV reflectometer by scanning the photodiode detector across the 2D angular range of the scatter. Both detection schemes were limited towards larger scatter angles by signal-to-noise ratio.
- The EUV scattering under grazing incidence is related to the surface topology of the sample because of total external reflection at the surface and corresponding very short penetration depth. Therefore, the results can be directly compared to AFM data.
- We obtain a reasonable agreement, given the slightly different spectral ranges of PSD for the two measurement approaches (i.e. Scatterometry and AFM)
- The agreement between the synchrotron radiation based measurements at PTB and the DPP laboratory set-up is within the expected margins, mainly determined by the sample homogeneity because of measuring beam footprint of both instruments was different in size.

References

- [1] C. Laubis, et al. "Update on EUV-Radiometry at PTB", Proc. SPIE, 977627 (2016)
- [2] O. Maryasov et al. "Table-top EUV scatterometer MARYS with high-brightness discharge plasma source", JARA-FIT Annual Report (2015)
- [3] F. Kuepper, K. Bergmann et al. "Source operation manual", Fraunhofer ILT (2014)